



CIRCLEPACK

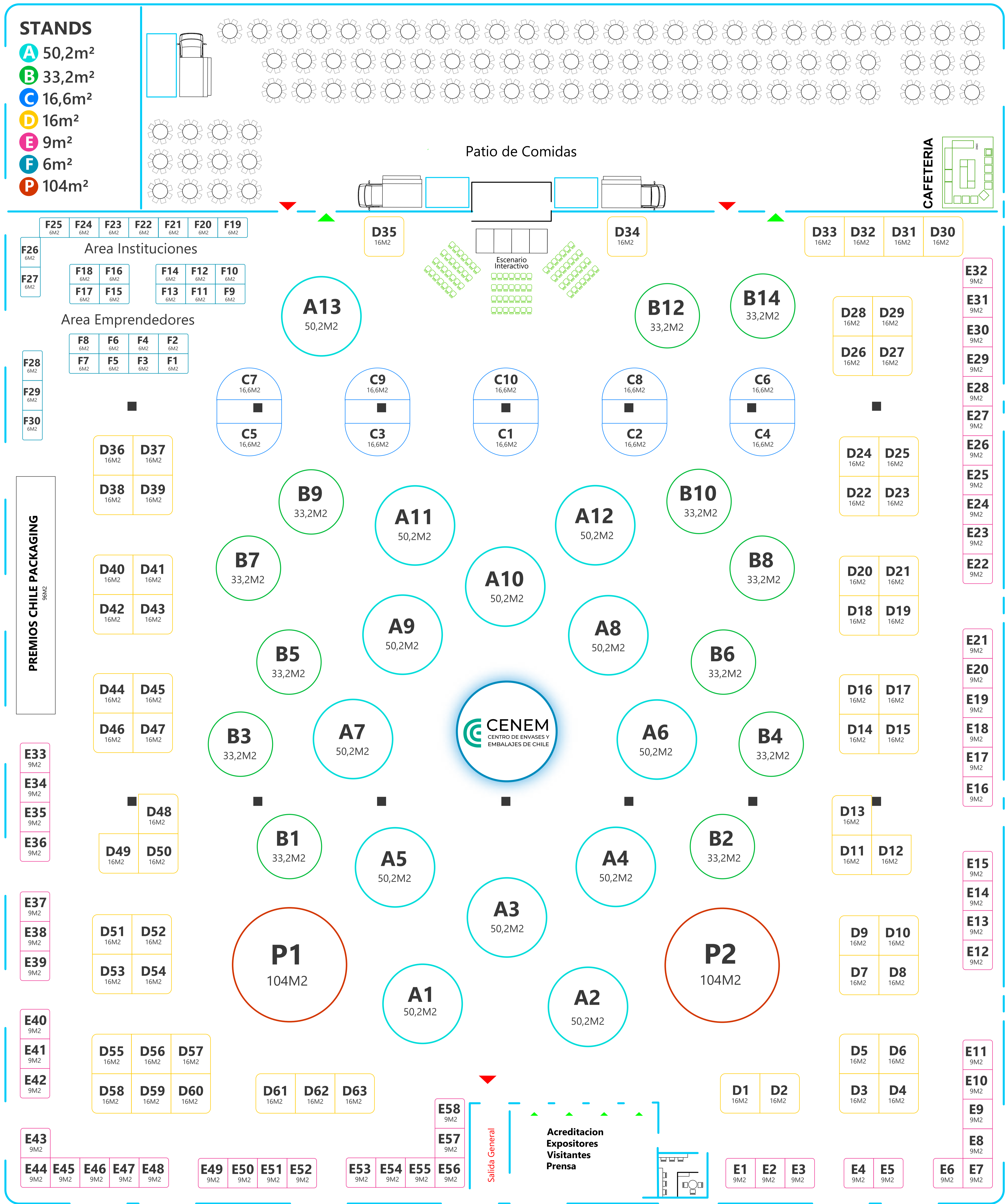
14·15·16 APRIL 2026

CENEM

CENTRO DE ENVASES Y
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High-Tech Packaging • Efficiency • Innovation • Sustainability

PLANO – FERIA INTERNACIONAL DE PACKAGING 2026



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